

Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectional	s Material Info	Subsection	als D, A
				Su	pplier Information				
Company Name	TE Connectivity Request Document I		D	C	Contact Name	enica, John R		Sr Mgr Environn Ind Central Eng	nental Engineering
Company Unique ID	TE Connectiv	vity Response I	Date 2017-12-1	3	Contact Email jr	penica@te.com			
Contact Phone	Number	1-717-592-3	266						
				L	_egal Statement				
Supplier Acceptance	true								
Legal Statemen	t								
							subject to change. nectivity (or its affilia		
					Product				
Manufacturer Item number	T207000101			179.7 Version			Identity		
Manufacturer Item Name	CAM-13	Weight Uor	n mg	ı	Mfr Site		Authority		
Date		UOM	Each						
EURoHS-0508	Product(s) meets EU RoHS requirements by application of the selected exemption(s)								
ChinaRoHS- 0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Can	didate Substances	of Very High Co	ncern AR	E NOT Contained i	n the Product Ab	ove the Limits per th	ne Definition with	nin REACH
				Pr	oduct Disclosure				
Sub- Item/Material/ Substance	Level	Name	Substance Category	Substar CAS	nce Substance Concentra		Mass per Un	it UOM	F
Material			1						Exemption
	1	PIN CONTACT- Silver plating				1.0	2.7	mg	Exemption
Substance	2	CONTACT-	Supplier	7440-22	-4 100.0		2.7	mg mg	Exemption
Substance Material	2 1	CONTACT- Silver plating	Supplier	7440-22	-4 100.0	1.0			Exemption
Material		CONTACT- Silver plating Silver	Supplier Lead/Lead Compounds	7440-22 7439-92		1.0	2.7	mg	6(c) Lead as an alloying element in copper containing up
Material Substance	1	CONTACT- Silver plating Silver PIN CONTACT	Lead/Lead		-1 1.8	1.0	2.7 177.0	mg mg	6(c) Lead as an alloying element in copper containing up to 4% lead by
Material Substance	1 2	CONTACT- Silver plating Silver PIN CONTACT Lead	Lead/Lead Compounds	7439-92	-9 0.0020	1.0 1.0 1.0 1.0	2.7 177.0 3.186	mg mg mg	6(c) Lead as an alloying element in copper containing up to 4% lead by
Material Substance	2	CONTACT- Silver plating Silver PIN CONTACT Lead Cadmium	Lead/Lead Compounds Cadmium/Cad mium Compounds	7439-92 7440-43	-9 0.0020 -6 38.858	1.0 1.0 1.0 1.0	2.7 177.0 3.186	mg mg mg	6(c) Lead as an alloying element in copper containing up to 4% lead by
Material Substance Substance Substance	2	CONTACT- Silver plating Silver PIN CONTACT Lead Cadmium Zinc	Lead/Lead Compounds Cadmium/Cad mium Compounds Supplier	7439-92 7440-43 7440-66	-9 0.0020 -6 38.858 -6 0.213	1.0 1.0 1.0 1.0 1.0	2.7 177.0 3.186 0.00354 68.77866	mg mg mg	6(c) Lead as an alloying element in copper containing up to 4% lead by